

IR-1839 (2-2729)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of

Mark Pavier

Date: May 28, 2003

Serial No.:

10/045,809

Group Art Unit: 2814

Filed:

January 11, 2002

Examiner: Phat X. Cao

For:

A-CLIP TYPE LEAD FRAME FOR SOURCE MOUNTED DIE

Commissioner of Patents P.O. Box 1450

Alexandria, VA 22313-1450

RESPONSE TO RESTRICTION REQUIREMENT

Sir:

This is in response to the Restriction Requirement dated May 13, 2003 in which restriction between the inventions of Group I and Group II was required.

Applicant elects the invention of Group I, Claims 1-15 drawn to semiconductor device structure without traverse.

Applicant reserves the right to file a divisional application directed to the subject matter covered in the non-elected claims 16-20.

A favorable action is respectfully requested.

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner of Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on May 28, 2003

Samuel H. Weiner

Name of applicant, assignee or Registered Representative

Signature May 28, 2003

Date of Signature

Respectfully submitted,

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